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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Scot A. KELLAR et al.
Serial No.: 10/066,645 ✓
Filed: February 6, 2002 ✓
For: DIELECTRIC RECESS FOR WAFER-TO-WAFER AND DIE-TO-DIE BONDING AND METHOD OF FABRICATING THE SAME
Group: 2811
Examiner: Not Yet Assigned

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TECHNOLOGY CENTER 2800

RESPONSE TO RESTRICTION REQUIREMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

May 23, 2003

Sir:

In response to the Restriction Requirement (Paper No. 5) dated May 9, 2003, Applicants hereby elect, without traverse, Group II (claim 8-20).

REMARKS

Claims 1-20 are pending in this application.

In response to the restriction requirement (Paper No. 5), in which the examiner indicates that two groups of inventions are being claimed; namely Group I (claims 1-7) drawn to a process of making semiconductor device, classified in class 438, subclass 455 and Group II (claims 8-20) drawn to a device, classified in class 257, subclass 777, Applicants respectfully elect, without traverse, the invention of Group II directed to claims 8-20. Non-elected Group I, drawn to claims 1-7, will be reinstated in a divisional application at an appropriate time